# Asynchronous Boost DC/DC Regulator

#### **Features**

Efficiency: up to 92%Input Voltage: 2.5V ~ 5V

 $\triangleright$  Output Voltage: 2.8V  $\sim$  5.5V

Delivers 5V at 2A from a 3V Input

➤ Internal MOSFET Switch

Low Rds(on) Switch

Minimal External Components

Low Profile SOT-23-6L Package

## **Applications**

- White LED Driver Supply
- > RF- Communications
- Battery Back-Up
- Portable Instrument
- Wireless Equipment

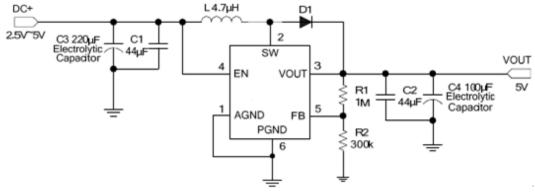
### Description

The JTMH3030 is a compact and high efficiency asynchronous step-up DC/DC converter. It can provide high efficiency even at heavy load by internal NMOS switch. The JTMH3030 generates an output voltage of up to 5.5V from an input voltage as low as 2.5V.

The JTMH3030 is ideal for applications where space is limited with tiny, low cost and low profile external components.

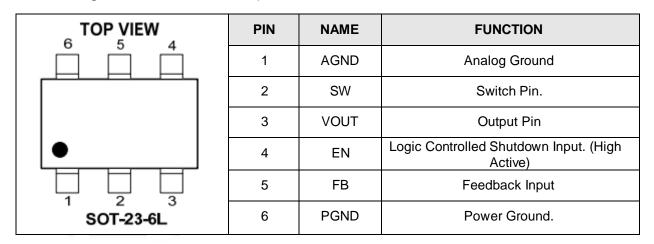
The JTMH3030 is available in a low profile SOT-23-6L package.

## **Typical Application Circuit**



\*Vou $\tau$ =1.212V · [1+R1/R2].

### Pin Assignment and Description



# Absolute Maximum Ratings (Note 1)

>	Supply Voltage	0.3V ~ 6.5V
>	SW Pin Switch Voltage	0.3V ~ 6.5V
>	Other I/O Pin Voltages	0.3V $\sim$ (VDD+0.3V)
>	Operating Temperature Range	40°C ∼ +85°C
>	Operating Junction Temperature	40°C ∼ +125°C
>	Storage Temperature Range	65°C ∼ +150°C
>	Lead Temperature	+ <b>265</b> ℃

**Note 1:** Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.

**Note 2:** The JTMH3030 is guaranteed to meet performance specifications from 0°C to 70°C. Specifications over the –40°C to 85°C operating temperature range are assured by design, characterization and correlation with statistical process controls.

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## **Electrical Characteristics**

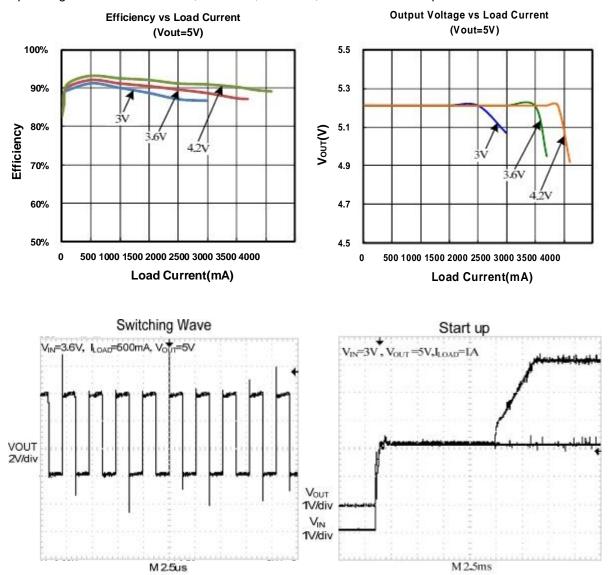
Operating Conditions: TA=25 °C, V<sub>IN</sub> = 3.6V, V<sub>OUT</sub> = 5V, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
VSTART	Start-up Voltage			2		V
Vouт	Output Voltage Range	VOUT Pin Voltage	2.8		5.5	V
lq	Supply Current (Quiescent)			700		μΑ
Ishdn	Supply Current (Shutdown)	VEN = 0V		15		μΑ
VFB	Feedback Reference Voltage		1.188	1.212	1.236	V
fosc	Switching Frequency	louт = 500mA		400		kHz
DC	Maximum Duty			100		%
Ron	SW ON Resistance	lоuт = 500mA		300		mΩ
VENH	EN High Threshold	VEN Rising	1.2			V
VENL	EN Low Threshold				0.6	V
len	EN Input Bias Current	VEN = 0V, 5V		50		μΑ

**Note:** The EN pin shall be tied to VDD pin and inhibit to act the ON/OFF state whenever the VDD pin voltage may reach to 5.5V or above.

# Typical Performance Characteristics

Operating Conditions: TA=25  $^{\circ}$ C, VIN=3.6V, VOUT=5V, unless otherwise specified.



### Pin Functions

AGND (Pin 1): Analog Ground.

**SW** (Pin 2): Switch Pin. Connect inductor between SW and VIN. Keep these PCB trace lengths as short and wide as possible to reduce EMI and voltage overshoot.

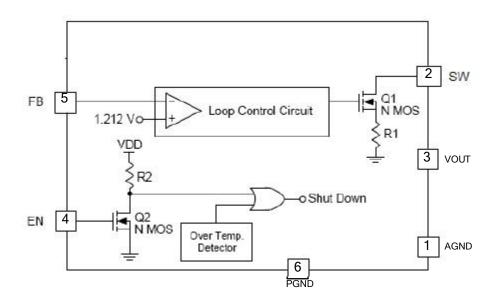
**VOUT (Pin 3):** Output Voltage Pin. PCB trace length from Vout to the output filter capacitor(s) should be as short and wide as possible.

**EN (Pin 4):** Logic Controlled Shutdown Input. EN=High: Normal free running operation. EN=Low: Shutdown.

FB (Pin 5): Feedback Input to the gm Error Amplifier. Connect resistor divider tap to this pin.

PGND (Pin 6): Power Ground.

## **Block Diagram**



### **Application Information**

#### **Inductor Selection**

For most applications, the value of the inductor will fall in the range of  $1\mu$ H to  $4.7\mu$ H. Its value is chosen based on the desired ripple current. Large value inductors lower ripple current and small value inductors result in higher ripple currents. Higher  $V_{IN}$  or  $V_{OUT}$  also increases the ripple current as shown in equation .A reasonable starting point for setting ripple current is  $I_L = 0.72A$  (40% of 1.8A).

$$\Delta I_L = \frac{1}{(f)(L)} V_{OUT} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$

The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. Thus, a 2.16A rated inductor should be enough for most applications (1.8A + 0.36A). For better efficiency, choose a low DC-resistance inductor.

Different core materials and shapes will change the size/current and price/current relationship of an inductor. Toroid or shielded pot cores in ferrite or perm alloy materials are small and don't radiate much energy, but generally cost more than powdered iron core inductors with similar electrical characteristics. The choice of which style inductor to use often depends more on the price vs. size requirements and any radiated field/EMI requirements than on what VOUT requires to operate.

#### **Output and Input Capacitor Selection**

In continuous mode, the source current of the top MOSFET is a square wave of duty cycle Vout/VIN. To prevent large voltage transients, a low ESR input capacitor sized for the maximum RMS current must be used. The maximum RMS capacitor current is given by:

$$C_{IN}$$
 required  $I_{RMS} \approx I_{OMAX} \frac{\left[V_{OUT}(V_{IN} - V_{OUT})\right]^{1/2}}{V_{IN}}$ 

This formula has a maximum at  $V_{IN} = 2V_{OUT}$ , where  $I_{RMS} = I_{OUT}/2$ . This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Note that the capacitor manufacturer's ripple current ratings are often based on 2000 hours of life. This makes it advisable to further derate the capacitor, or choose a capacitor rated at a higher temperature than required. Always consult the manufacturer if there is any question.

The selection of Cout is driven by the required effective series resistance (ESR). Typically, once the ESR requirement for Cout has been met, the RMS current rating generally far exceeds the IRIPPLE(P-P) requirement. The output ripple  $\Delta$ Vout is determined by:

$$\Delta V_{OUT} \simeq \Delta I_L \left( ESR + \frac{1}{8fC_{OUT}} \right)$$

Where f = operating frequency,  $Cou\tau$  = output capacitance and  $\Delta IL$  = ripple current in the inductor. For a fixed output voltage, the output ripple is highest at maximum input voltage since  $\Delta IL$  increases with input voltage.

Aluminum electrolytic and dry tantalum capacitors are both available in surface mount configurations. In the case of tantalum, it is critical that the capacitors are surge tested for use in switching power supplies. An excellent choice is the AVX TPS series of surface mount tantalum. These are specially constructed and tested for low ESR.

#### **Efficiency Considerations**

The efficiency of a switching regulator is equal to the output power divided by the input power times 100%. It is often useful to analyze individual losses to determine what is limiting the efficiency and which change would produce the most improvement. Efficiency can be expressed as: Efficiency = 100% - (L1+ L2+ L3+ ...) where L1, L2, etc. are the individual losses as a percentage of input power. Although all dissipative elements in the circuit produce losses, two main sources usually account for most of the losses: VIN quiescent current and I2R losses. The VIN quiescent current loss dominates the efficiency loss at very low load currents whereas the I2R loss dominates the efficiency loss at medium to high load currents. In a typical efficiency plot, the efficiency curve at very low load currents can be misleading since the actual power lost is of no consequence.

- 1. The VIN quiescent current is due to two components: the DC bias current as given in the electrical characteristics and the internal main switch and synchronous switch gate charge currents. The gate charge current results from switching the gate capacitance of the internal power MOSFET switches. Each time the gate is switched from high to low to high again, a packet of charge  $\Delta Q$  moves from VIN to ground. The resulting  $\Delta Q/\Delta t$  is the current out of VIN that is typically larger than the DC bias current. In continuous mode, IGATECHG = f (QT+QB) where QT and QB are the gate charges of the internal top and bottom switches. Both the DC bias and gate charge losses are proportional to VIN and thus their effects will be more pronounced at higher supply voltages.
- 2. I2R losses are calculated from the resistances of the internal switches, Rsw and external inductor RL. In continuous mode the average output current flowing through inductor L is "chopped" between the main switch and the synchronous switch. Thus, the series resistance looking into the SW pin is a function of both top and bottom MOSFET RDS(ON) and the duty cycle (DC) as follows: Rsw = RDS(ON)TOP x DC + RDS(ON)BOT x (1-DC) The RDS(ON) for both the top and bottom MOSFETs can be obtained from the Typical Performance Characteristics curves. Thus, to obtain I2R losses, simply add Rsw to RL and multiply the result by the square of the average output current. Other losses including CIN and COUT ESR dissipative losses and inductor core losses generally account for less than 2% of the total loss.

#### **Board Layout Suggestions**

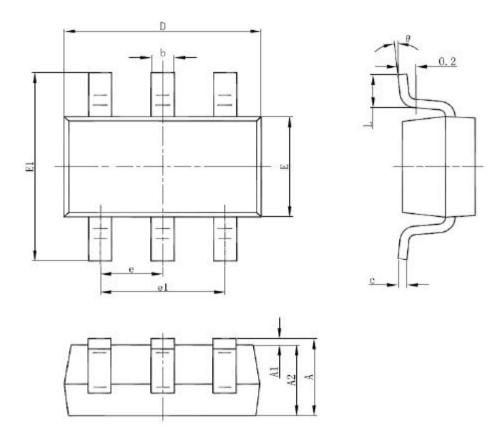
When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the JTMH3030. Check the following in your layout:

- 1. The power traces, consisting of the GND trace, the SW trace and the VIN trace should be kept short, direct and wide.
- Put the input capacitor as close as possible to the device pins (VIN and GND).
- 3. SW node is with high frequency voltage swing and should be kept small area. Keep analog components away from SW node to prevent stray capacitive noise pick-up.
- 4. Connect all analog grounds to a command node and then connect the command node to the power ground behind the output capacitors.

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# Packaging Information

# SOT-23-6L Package Outline Dimension



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Cymbol	Min	Max	Min	Max	
Α	1.050	1.250	0.041	0.049	
A1	0.000	0.100	0.000	0.004	
A2	1.050	1.150	0.041	0.045	
b	0.300	0.500	0.012	0.020	
С	0.100	0.200	0.004	0.008	
D	2.820	3.020	0.111	0.119	
E	1.500	1.700	0.059	0.067	
E1	2.650	2.950	0.104	0.116	
е	e 0.950(BSC)		0.037(BSC)		
e1	1.800	2.000	0.071	0.079	
L	0.300	0.600	0.012	0.024	
θ	0°	8°	0°	8°	